

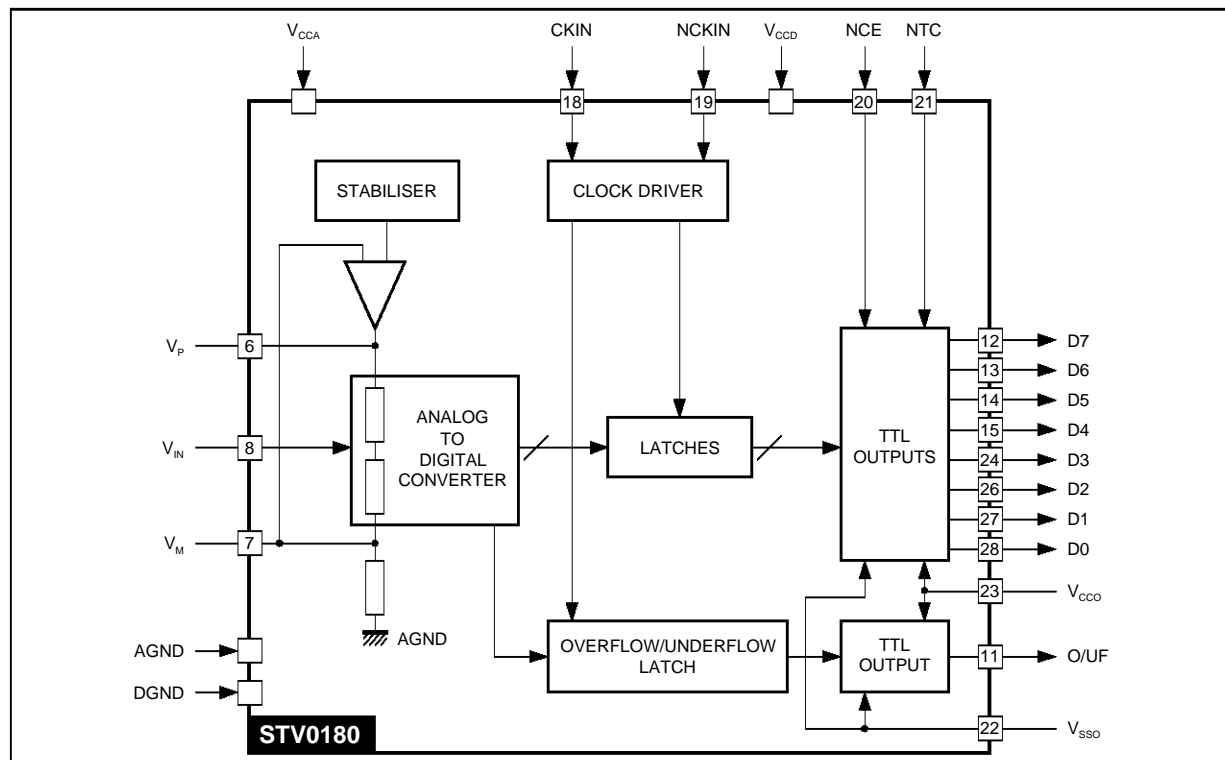


**PIN DESCRIPTION**

Pin N°	Name	Description
1	V <sub>DD</sub>	Positive Supply Voltage for Digital Part (5V)
2	GND	Digital Ground
3	AGND	Analog Ground
4	NC	Not Connected
5	V <sub>CCA</sub>	Positive Supply Voltage for Analog Part (5V)
6	V <sub>P</sub>	Top Reference Voltage Decoupling
7	V <sub>M</sub>	Bottom Reference Voltage Decoupling
8	V <sub>IN</sub>	Analog Voltage Input
9	V <sub>CCA</sub>	Positive Supply Voltage for Analog Part
10	AGND	Analog Ground
11	O/UF	Overflow/Underflow Data Output
12	D7	Data Output Bit 7 (MSB)
13	D6	Data Output Bit 6
14	D5	Data Output Bit 5
15	D4	Data Output Bit 4
16	V <sub>SSO</sub>	Ground for Output Stages
17	V <sub>CCO</sub>	Positive Supply Voltage for Output Stages (5V)
18	CKIN	Clock Input
19	NCKIN	Negative Clock Input
20	NCE	Chip Enable Input (TTL Level, Active Low)
21	NTC	Input for 2's Complement Output (TTL Level, Active Low)
22	V <sub>SSO</sub>	Ground for Digital Outputs
23	V <sub>CCO</sub>	Positive Supply Voltage for Output Stages (5V)
24	D3	Data Output Bit 3
25	NC	Not Connected
26	D2	Data Output Bit 2
27	D1	Data Output Bit 1
28	D0	Data Output Bit 0 (LSB)

0180-01.TBL

**BLOCK DIAGRAM**



0180-02.EPS

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
$V_{CCA}$	Analog Supply Voltage		-0.3	7	V
$V_{DD}$	Digital Supply Voltage		-0.3	7	V
$V_{CCO}$	Output Stages Voltage Supply		-0.3	7	V
$V_{CCA} - V_{CCD}$	Supply Voltage Differences		-1	1	V
$V_{CCA} - V_{DD}$	Supply Voltage Differences		-1	1	V
$V_{CCO} - V_{DD}$	Supply Voltage Differences		-3	1	V
$V_{VI}$	Input Voltage	Referenced to AGND	-0.3	7	V
$I_O$	Output current		-10	10	mA
$T_{amb}$	Operating Ambient Temperature		0	70	°C

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## STV0180

### ELECTRICAL CHARACTERISTICS

$V_{DD} = V_{CCA} = V_{CCO} = 4.75$  to  $5.25$ V,  $GND = AGND = V_{SSO} = 0$ V

$T_{amb} = 0$  to  $70^{\circ}$ C

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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#### SUPPLIES

$V_{CCO}$	Output Supply Voltage		4.75	5	5.25	V
$V_{DD}$	Digital Supply Voltage		4.75	5	5.25	V
$V_{CCA}$	Analog Supply Voltage		4.75	5	5.25	V

#### DIGITAL OUTPUTS ( $I_o = 1$ mA)

$V_{OL}$	Low Level Output Voltage				0.4	V
$V_{OH}$	High Level Output Voltage		$V_{CCO} - 0.4$			V
$I_{OZ}$	Output Current in 3 State Mode		-20		20	$\mu$ A

#### DIGITAL INPUTS (NTC, TCE)

$V_{IL}$	Low Level Input Voltage		0	-0.4		V
$V_{IH}$	High Level Input Voltage		2		$V_{DD}$	V
$I_{IL}$	Low Level Input Current		-20		20	$\mu$ A
$I_{IH}$	High Level Input Current		-20		20	$\mu$ A

#### CLOCK INPUTS (CKIN, NCKIN)

$V_{IL}$	Low Level Input Voltage		0		0.8	V
$V_{IH}$	High Level Input Voltage		2		$V_{CCA}$	V
$I_{IL}$	Low Level Input Current		-500			$\mu$ A
$I_{IH}$	High Level Input Current				500	$\mu$ A
$Z_I$	Input Impedance ( $f_{IN} = 10$ MHz)		3			k $\Omega$
$C_I$	Input Capacitance ( $f_{IN} = 10$ MHz)			6		pF
$V_{CKIN}$ (pp)	Peak to Peak Differential Clock Input Voltage (1.6V DC Bias)		0.5		2	V

#### $V_{IN}$ ANALOG VOLTAGE REFERENCED TO AGND

$V_{VIN}(B)$	Input Voltage (Bottom)			2.1		V
$V_{VIN}(0)$	Input Voltage (Output Code = 0)			2.26		V
$V_{VIN}(T)$	Input Voltage (Top)			3.7		V
$V_{VIN}(255)$	Input Voltage (Output Code = 255)			3.54		V
$V_{VIN}(pp)$	Input Voltage (Peak to Peak Value)		1.2	1.28	1.35	V
$I_{IL}$	Low Level Input Current ( $V_{VIN} = 2.1$ V)			10		$\mu$ A
$I_{IH}$	High Level Input Current ( $V_{VIN} = 3.7$ V)		50	150	200	$\mu$ A

#### REFERENCE RESISTANCE

$R_{REF}$	Reference Resistance			200		$\Omega$
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#### ANALOG SIGNAL PROCESSING ( $f_{clk} = 30$ MHz)

ILE	DC Integral Linearity Error				$\pm 1$	LSB
DLE	DC Differential Linearity Error				$\pm 0.5$	LSB
AILE	AC Integral Error ( $f_{IN} = 4.4$ MHz)				$\pm 2$	LSB
Eff	Effective Bits ( $f_{IN} = 4.4$ MHz)			7.1		Bits
BW	-0.6dB Analog Bandwidth			14		MHz

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**ELECTRICAL CHARACTERISTICS** (Continued)

$V_{DD} = V_{CCA} = V_{CCO} = 4.75$  to  $5.25V$ ,  $GND = AGND = V_{SSO} = 0V$

$T_{amb} = 0$  to  $70^{\circ}C$

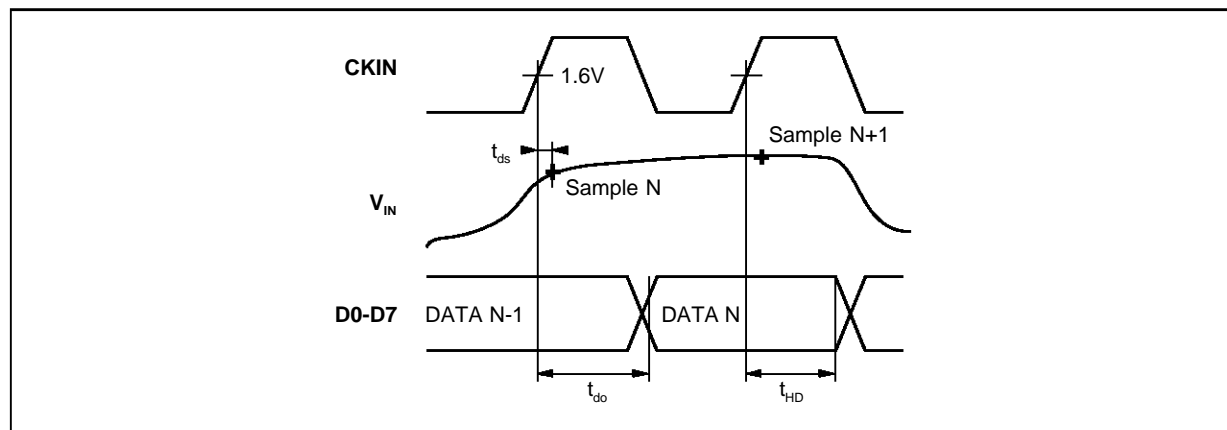
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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TIMING (Figures 1 and 2)

$t_{ds}$	Sampling Delay				2	ns
$t_{HD}$	Output Hold Time		5			ns
$t_{do}$	Output Delay Time				20	ns
$t_{dz}$	3 State Output Delay Time				25	ns

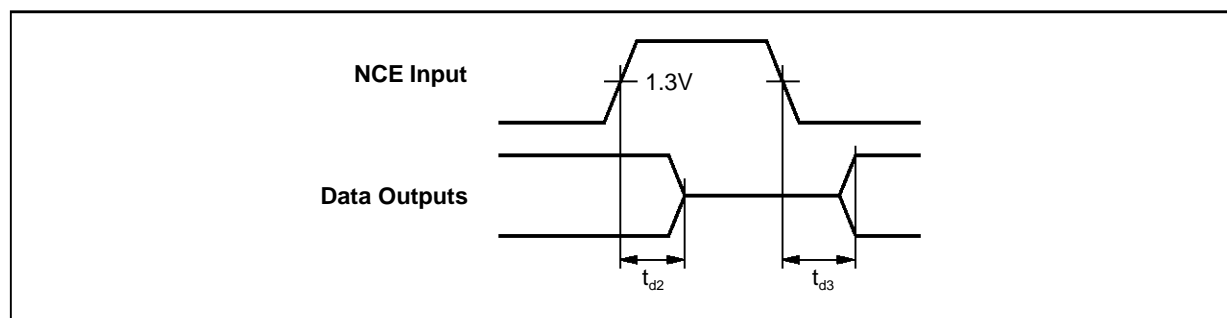
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**Figure 1 : Timing Diagram**



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**Figure 2 : 3 State Delay Timing Diagram**



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## STV0180

The circuit has two clock inputs CKIN and NCKIN. There are four modes of operation.

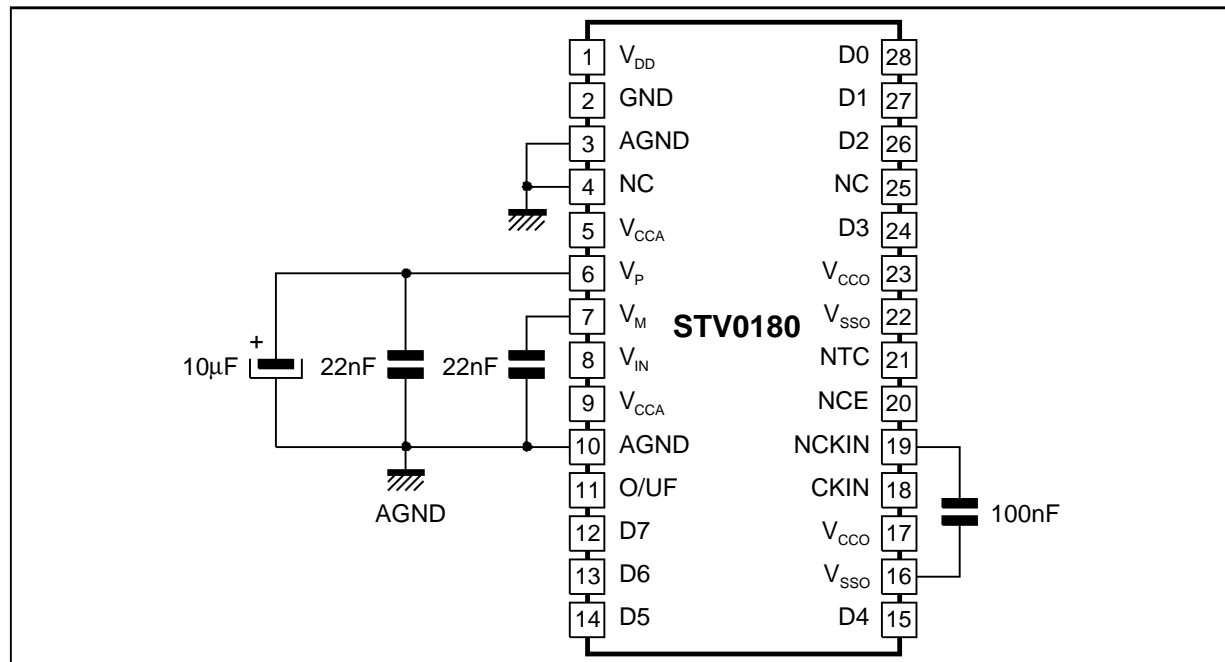
TTL ; NCKIN decoupled to  $V_{SSO}$  by a capacitor. CLK input is TTL threshold voltage of 1.6V and sampling on the LOW to HIGH transition of the input clock signal.

TTL ; CKIN decoupled to  $V_{SSO}$  by a capacitor. NCKIN input is TTL threshold voltage of 1.6V and sampling on a HIGH to LOW transistor.

AC drive mode ; When driving CKIN (NCKIN) input directly and with an AC signal of 0.5V (peak to peak value) imposed on a DC value of 1.6V sampling takes place on the LOW to HIGH (HIGH to LOW) transition of the clock signal.

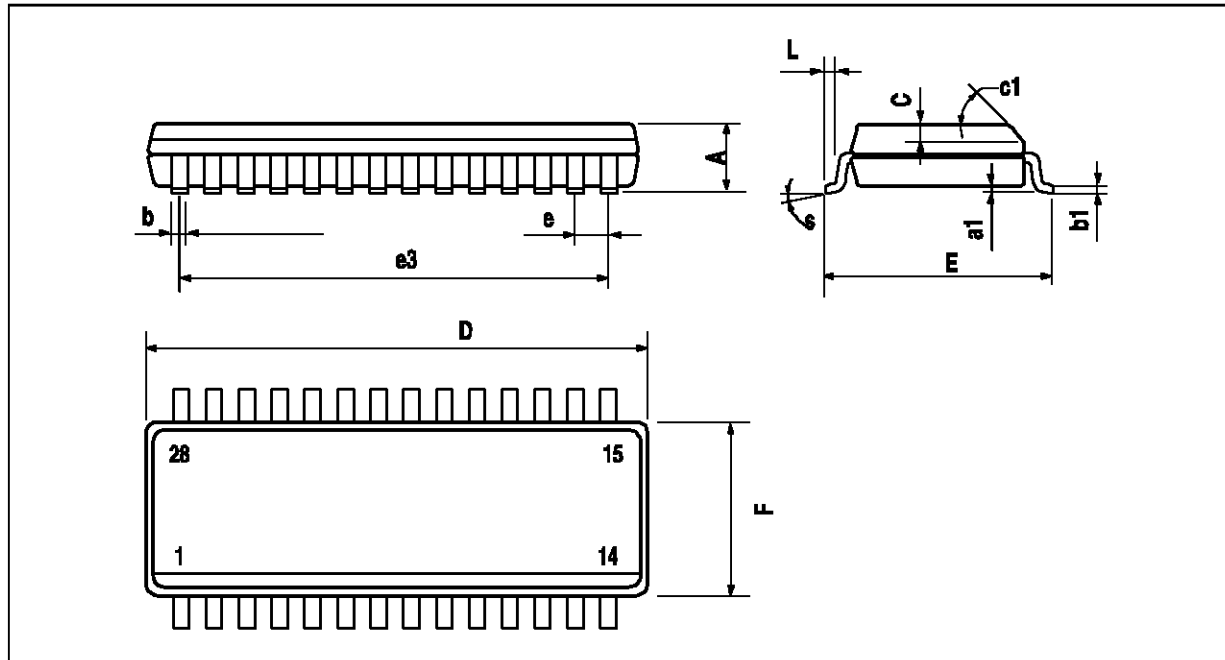
If one of the clock inputs is not driven, it is recommended to decouple this input to  $V_{SSO}$  with a 100nF capacitor.

### TYPICAL APPLICATION



0180\_06.EPS

**PACKAGE MECHANICAL DATA**  
28 PINS - PLASTIC MICROPACKAGE (SO)



PM-SO28.EPS

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			2.65			0.104
a1	0.1		0.3	0.004		0.012
b	0.35		0.49	0.014		0.019
b1	0.23		0.32	0.009		0.013
C		0.5			0.020	
c1	45° (typ.)					
D	17.7		18.1	0.697		0.713
E	10		10.65	0.394		0.419
e		1.27			0.050	
e3		16.51			0.65	
F	7.4		7.6	0.291		0.299
L	0.4		1.27	0.016		0.050
S	8° (max.)					

SO28.TBL

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